L Number	Hits	Search Text	DB	Time stamp
1	139	fan.in. and mold$3	USPAT; US-PGPUB; DERWENT	2002/08/26 14:31
2	0	(fan.in. and mold$3) and 422/68.1.ccls.	USPAT; US-PGPUB; DERWENT	2002/08/26 14:32
3	4	(fan.in. and mold$3) and template	USPAT; US-PGPUB; DERWENT	2002/08/26 14:36
4	4	(fan.in. and mold$3) and well near5 mold$3	USPAT; US-PGPUB; DERWENT	2002/08/26 14:34
5	4	((fan.in. and mold$3) and well near5 mold$3) not ((fan.in. and mold$3) and template)	USPAT; US-PGPUB; DERWENT	2002/08/26 14:34
6	23118	well near5 mold$3	USPAT; US-PGPUB; DERWENT	2002/08/26 14:35
7	110	435/6.ccls. and (well or cell or site) near5 mold$3	USPAT; US-PGPUB; DERWENT	2002/08/26 14:35
10	1	((435/6.ccls. and (well or cell or site) near5 mold$3) and (stamp$3 or inject$3) near4 mold$) and ((microarray or "gene chip" or "gene array" or "dna chip" or "dna array" or biochip) same (stamp or mold))	USPAT; US-PGPUB; DERWENT	2002/08/26 14:41
9	20	(microarray or "gene chip" or "gene array" or "dna chip" or "dna array" or biochip) same (stamp or mold)	USPAT; US-PGPUB; DERWENT	2002/08/26 15:03
8	34	(435/6.ccls. and (well or cell or site) near5 mold$3) and (stamp$3 or inject$3) near4 mold$	USPAT; US-PGPUB; DERWENT	2002/08/26 14:46
11	0	(microarray or "gene chip" or "gene array" or "dna chip" or "dna array" or biochip) same (template near4 mold)	USPAT; US-PGPUB; DERWENT	2002/08/26 15:08
12	0	(microarray or "gene chip" or "gene array" or "dna chip" or "dna array" or biochip) same (template near4 stamp)	USPAT; US-PGPUB; DERWENT	2002/08/26 14:59
14	0	((microarray or "gene chip" or "gene array" or "dna chip" or "dna array" or biochip) same (stamping or molding)) and (microarray or "gene chip" or "gene array" or "dna chip" or "dna array" or biochip) same (stamping or molding) near4 (wells or cells)	USPAT; US-PGPUB; DERWENT	2002/08/26 15:05
15	0	((microarray or "gene chip" or "gene array" or "dna chip" or "dna array" or biochip) same (stamping or molding)) and (stamping or molding) near4 (wells or cells)	USPAT; US-PGPUB; DERWENT	2002/08/26 15:05
13	16	(microarray or "gene chip" or "gene array" or "dna chip" or "dna array" or biochip) same (stamping or molding)	USPAT; US-PGPUB; DERWENT	2002/08/26 15:05
16	0	(microarray or "gene chip" or "gene array" or "dna chip" or "dna array" or biochip) and mold near5 projection	USPAT; US-PGPUB; DERWENT	2002/08/26 15:09
17	2	(microarray or "gene chip" or "gene array" or "dna chip" or "dna array" or biochip) and (stamp or template) near5 projection	USPAT; US-PGPUB; DERWENT	2002/08/26 15:09
18	7	5731152.URPN.	USPAT	2002/08/26 15:12

L Number	Hits	Search Text	DB	Time stamp
1	18	435/6.ccls. and (microtiter or multiwell) near8 (adhere or adhesion or attach or glue or adhesive)	USPAT; DERWENT	2002/08/26 12:10
2	269	"fiber optic" near8 mold$3	USPAT; DERWENT	2002/08/26 12:11
3	134	"fiber optic" near3 mold$3	USPAT; DERWENT	2002/08/26 12:11
4	176	(fiber near2 bundle) near3 mold$3	USPAT; DERWENT	2002/08/26 12:11
5	0	((fiber near2 bundle) near3 mold$3) and 435/6.ccls.	USPAT; DERWENT	2002/08/26 12:43
6	0	((fiber near2 bundle) near3 mold$3) and walt.in.	USPAT; DERWENT	2002/08/26 12:12
7	0	("fiber optic" near3 mold$3) and walt.in.	USPAT; DERWENT	2002/08/26 12:12
8	0	("fiber optic" near8 mold$3) and walt.in.	USPAT; DERWENT	2002/08/26 12:12
9	0	("fiber optic" near8 mold$3) and 435/6.ccls.	USPAT; DERWENT	2002/08/26 12:12
10	1	("fiber optic" near8 mold$3) and 422/68.1.ccls.	USPAT; DERWENT	2002/08/26 12:12
11	10	gel adj pad and 435/6.ccls.	USPAT; DERWENT	2002/08/26 12:56
12	14	nova.in. and 435/6.ccls.	USPAT; DERWENT	2002/08/26 13:03
13	13	(nova.in. and 435/6.ccls.) and (bead or microsphere)	USPAT; DERWENT	2002/08/26 13:03
14	7	((nova.in. and 435/6.ccls.) and (bead or microsphere)) and mold$3	USPAT; DERWENT	2002/08/26 12:57
15	23	heller.in. and 435/6.ccls.	USPAT; DERWENT	2002/08/26 13:31
16	3	(heller.in. and 435/6.ccls.) and mold$3 and (bead or microsphere)	USPAT; DERWENT	2002/08/26 13:30
17	8	(heller.in. and 435/6.ccls.) and (bead or microsphere)	USPAT; DERWENT	2002/08/26 13:04
18	4	((heller.in. and 435/6.ccls.) and (bead or microsphere)) and layer same (adhere or adhesion or bond$3)	USPAT; DERWENT	2002/08/26 13:42
19	8	(heller.in. and 435/6.ccls.) and mold$3	USPAT; DERWENT	2002/08/26 13:30
20	3	((heller.in. and 435/6.ccls.) and mold$3) and ((heller.in. and 435/6.ccls.) and (bead or microsphere))	USPAT; DERWENT	2002/08/26 13:30
21	4	bogart.in. and 435/6.ccls.	USPAT; DERWENT	2002/08/26 13:31
22	3	(bogart.in. and 435/6.ccls.) and layer same (adhere or adhesion or bond$3)	USPAT; DERWENT	2002/08/26 13:31
23	3	(bogart.in. and 435/6.ccls.) and mold$4	USPAT; DERWENT	2002/08/26 13:31
24	3	((bogart.in. and 435/6.ccls.) and layer same (adhere or adhesion or bond$3)) and ((bogart.in. and 435/6.ccls.) and mold$4)	USPAT; DERWENT	2002/08/26 13:34
25	3	(((bogart.in. and 435/6.ccls.) and layer same (adhere or adhesion or bond$3)) and ((bogart.in. and 435/6.ccls.) and mold$4)) and (bead or microsphere)	USPAT; DERWENT	2002/08/26 13:41
26	2	5840256.pn.	USPAT; DERWENT	2002/08/26 13:42
27	13	5840256.URPN.	USPAT	2002/08/26 13:41
28	7	5840256.URPN. and mold$4	USPAT; DERWENT	2002/08/26 13:42
29	8	5840256.URPN. and (bead or microsphere)	USPAT; DERWENT	2002/08/26 13:42
30	1	5840256.URPN. and layer same (adhere or adhesion or bond$3)	USPAT; DERWENT	2002/08/26 13:43
32	9	(5840256.URPN. and mold$4) or (5840256.URPN. and (bead or microsphere))	USPAT; DERWENT	2002/08/26 13:43
33	0	(5840256.URPN. and layer same (adhere or adhesion or bond$3)) and ((5840256.URPN. and mold$4) or (5840256.URPN. and (bead or microsphere)))	USPAT; DERWENT	2002/08/26 13:43

31	6	(5840256.URPN. and mold$4) and (5840256.URPN. and (bead or microsphere))	USPAT; DERWENT	2002/08/26 13:47
34	3	((5840256.URPN. and mold$4) or (5840256.URPN. and (bead or microsphere))) not ((5840256.URPN. and mold$4) and (5840256.URPN. and (bead or microsphere)))	USPAT; DERWENT	2002/08/26 13:47
35	0	(((5840256.URPN. and mold$4) or (5840256.URPN. and (bead or microsphere))) not ((5840256.URPN. and mold$4) and (5840256.URPN. and (bead or microsphere)))) and (5840256.URPN. and layer same (adhere or adhesion or bond$3))	USPAT; DERWENT	2002/08/26 13:47
36	4	(((5840256.URPN. and mold$4) or (5840256.URPN. and (bead or microsphere))) not ((5840256.URPN. and mold$4) and (5840256.URPN. and (bead or microsphere)))) or (5840256.URPN. and layer same (adhere or adhesion or bond$3))	USPAT; DERWENT	2002/08/26 13:47